2SJ0536

Silicon P-channel MOSFET

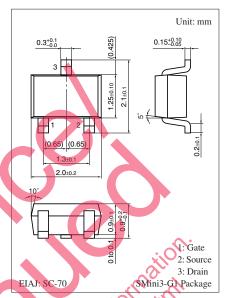
Secondary battery packs (Li ion battery, etc.) For switching circuits

■ Features

- High-speed switching
- S-mini type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing
- Low voltage drive (V_{th}: -1.0 V to 2.0 V)
- Low ON resistance

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Drain-sourse surrender voltage	V_{DSS}	-30	V	
Gate-source voltage (Drain open)	V_{GSO}	±20	V	
Drain current	I_D	-100	mA	
Peak drain current	I_{DP}	-200	mA	
Power dissipation	P_{D}	150	mW	
Channel temperature	T _{ch}	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



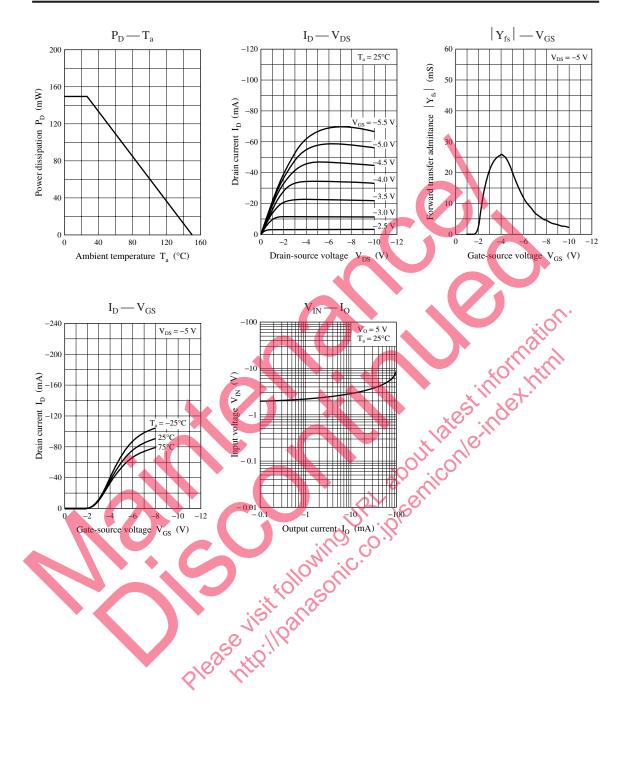
Marking Symbol: 20

■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Drain current	I_{D}	-100	mA			(0)	, ×()		
Peak drain current	I_{DP}	-200	mA	Marking S	Symbol	: 20	Nr		
Power dissipation	P_{D}	150	mW		a X	· ``` \ é	*		
Channel temperature	T _{ch}	150	°C		XO'	$''_{O_{\sigma}}$			
Storage temperature	T _{stg} -	-55 to +150	°C	X	0 10				
Peak drain current I_{DP} −200 mA Marking Symbol: 2C Marking Symbo									
■ Electrical Characteristics T	- 25°C	+ 3°C		you il	5				
Liectrical Characteristics 1	a - 25 C	130	<u> </u>	0,0,					
Parameter	Symbol		Conditions	150	Min	Тур	Max	Unit	
Drain-source cutoff current	I_{DSS}	$V_{DS} = -30$	0 V, V _{GS} = 0	8,			- 0.1	μΑ	
Gate-source cutoff current	I _{GSS}	$V_{GS} = \pm 20$	$0 \text{ V, V}_{DS} = 0$,			±1.0	μΑ	
Gate threshold voltage	V _{th}		$V, I_D = -1 \mu A$		-1.0		-2.0	V	
Forward transfer admittance	Y _{fs}	V _{DS} = -5	$V, I_D = -10 \text{ mA}$		8			mS	
Drain-source ON resistance	R _{DS(on)}		$N_{\rm D} = -10 \text{mA}$			50	75	Ω	
Turn-on time	t _{on}		$V, V_{GS} = 0 V \sim -5$	5 V		100		μs	
	0,	$R_L = 200$	Ω						
Turn-off time	A _{off}	D	V , $V_{GS} = -5 V \sim 0$) V		25		μs	
		$R_{L} = 200$	Ω						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Observe precautions for handling. Electrostatic sensitive devices.



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